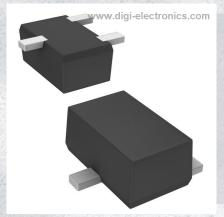


2SC39380RL Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number 2SC39380RL-DG

Manufacturer Panasonic Electronic Components

Manufacturer Product Number 2SC39380RL

Description TRANS NPN 40V 0.1A SMINI3

Detailed Description Bipolar (BJT) Transistor NPN 40 V 100 mA 450MHz 1

50 mW Surface Mount SMini3-G1



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
25C39380RL	Panasonic Electronic Components
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
NPN	100 mA
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, Ic:
40 V	250mV @ 1mA, 10mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
100nA (ICBO)	90 @ 10mA, 1V
Power - Max:	Frequency - Transition:
150 mW	450MHz
Operating Temperature:	Mounting Type:
150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
SC-70, SOT-323	SMini3-G1
Base Product Number:	
2SC3938	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	ECCN:
1 (Unlimited)	EAR99
HTSUS:	
8541.21.0075	

2SC3938

Silicon NPN epitaxial planar type

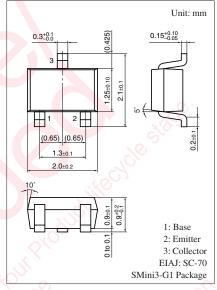
For high-speed switching

■ Features

- ullet Low collector-emitter saturation voltage $V_{CE(sat)}$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	40	V	
Collector-emitter voltage (E-B short)	V _{CES}	40	V	
Emitter-base voltage (Collector open)	V_{EBO}	5	V	
Collector current	I_C	100	mA	
Peak collector current	I_{CP}	300	mA	
Collector power dissipation	P _C	150	mW	
Junction temperature	T_{j}	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



Marking Symbol: 2Y

■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

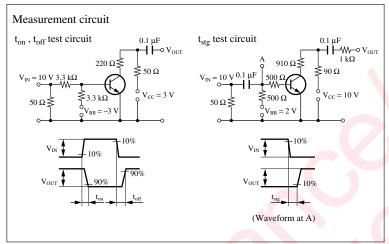
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 40 \text{ V}, I_{E} = 0$	71)		0.1	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 4 \text{ V}, I_{C} = 0$	100	250	0.1	μΑ
Forward current transfer ratio *	h_{FE}	$V_{CE} = 1 \text{ V}, I_{C} = 10 \text{ mA}$	60	0	200	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$	1.90	0.17	0.25	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$			1	V
Transition frequency	f_T	$V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$		450		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2	6	pF
Turn-on time	t _{on}	Refer to the measurement circuit		17		ns
Turn-off time	t _{off}			17		ns
Storage time	t _{stg}	and the second		10		ns

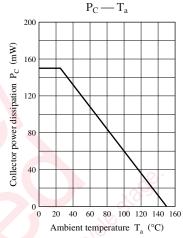
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

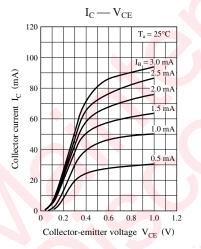
2. *: Rank classification

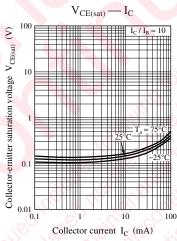
Rank	Q	R
h_{FE}	60 to 120	90 to 200

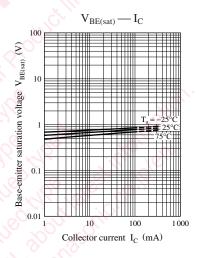
Panasonic

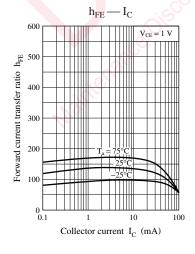


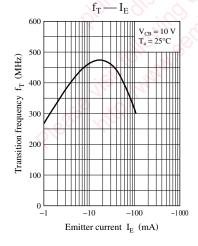


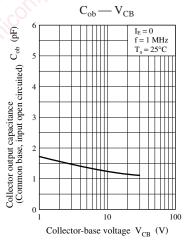












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